Xinyi Zhang

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EDUCATION

Ph. D. in Engineering 04/2020 – 09/2023

Graduate School of Engineering Science, Osaka University, Japan

Advisor: Prof. Kensuke Harada

Master of Engineering 04/2018 – 03/2020

Graduate School of Engineering Science, Osaka University, Japan

Advisor: Prof. Kensuke Harada

Bachelor 09/2012 - 07/2016

Information Management and Information System, Tianjin University, China

WORK EXPERIENCE

Researcher 10/2023 - Present

Sony R&D

PUBLICATIONS

Journal Paper (Peer-Reviewed)

- [1] Xinyi Zhang*, Yukiyasu Domae, Weiwei Wan, Kensuke Harada A Closed-Loop Bin Picking System for Entangled Wire Harnesses using Bimanual and Dynamic Manipulation. 2023. webpage, paper.
- [2] **Xinyi Zhang***, Yukiyasu Domae, Weiwei Wan, Kensuke Harada. Learning to Dexterously Pick or Separate Tangled-Prone Parts for Industrial Bin Picking. IEEE Robotics and Automation Letters (RA-L), 2023. webpage, paper.
- [3] **Xinyi Zhang***, Yukiyasu Domae, Weiwei Wan, Kensuke Harada. Learning a Sequential Policy of Efficient Actions for Tangled-Prone Parts in Robotic Bin Picking. IEEE Robotics and Automation Letters (RA-L), 2022. (Presented at ICRA 2023). webpage, paper.
- [4] Kaidi Nie, Felix von Drigalski, Joshua C. Triyonoputro, Chisato Nakashima, Yoshiya Shibata, Yoshinori Konishi, Yoshihisa Ijiri, Taku Yoshioka, Yukiyasu Domae, Toshio Ueshiba, Ryuichi Takase, Xinyi Zhang, Damien Petit, Ixchel G. Ramirez-Alpizar, Weiwei Wan & Kensuke Harada. Team O2AS' approach for the task-board task of the World Robot Challenge 2018. Advanced Robotics, 2020. paper.

International Conferences (Peer-Reviewed)

- [5] Mizuki Takasu, **Xinyi Zhang***, Yukiyasu Domae, Weiwei Wan, Kensuke Harada. Industrial Bin Picking of Potential Entangled Objects in Dense Clutter by Skeletonized Shape Restoration. 18th International Symposium on Experimental Robotics (ISER), 2023.
- [6] **Xinyi Zhang***, Keisuke Koyama, Yukiyasu Domae, Weiwei Wan, Kensuke Harada. A Topological Solution of Entanglement for Complex-shaped Parts in Robotic Bin-picking. IEEE International

Conference on Automation Science and Engineering (CASE), 2021. (IEEE Robotics and Automation Society Japan Joint Chapter Young Award). paper.

Domestic Conferences

- [7] Mizuki Takasu, **Xinyi Zhang**, Yukiyasu Domae, Weiwei Wan, Kensuke Harada. Bin-Picking for Potential Entangled Object by Linearing Image of the Pile. SI2022. (Best Presentation Award)
- [8] **Xinyi Zhang**, Weiwei Wan, Yukiyasu Domae, Kensuke Harada. Learning Dexterous Bin Picking Policies for Picking and Separating Tangled-Prone Parts. RSJ2022.
- [9] **Xinyi Zhang**, Yukiyasu Domae, Weiwei Wan, Kensuke Harada. Efficiently Picking Tangled-Prone Parts by Learning a Sequential Bin Picking Policy. SICE SI2021. (Best Presentation Award)
- [10] Xinyi Zhang, Keisuke Koyama, Yukiyasu Domae, Weiwei Wan, Kensuke Harada. Topology-based Grasp Detection Avoiding Entanglement for Robotic Bin-picking. SI2020. (Young Scientist Incentive Award, Best Presentation Award)
- [11] **Xinyi Zhang**, Keisuke Koyama, Weiwei Wan, Yukiyasu Domae, Kensuke Harada. Motion Generation for Separating Tangled Objects in Robotic Bin-picking. SCI'20.
- [12] **Xinyi Zhang**, Damien Petit, Yukiyasu Domae, Ixchel G. Ramirez-Alpizar, Weiwei Wan, Kensuke Harada. Error Analysis and Adjustment on Randomized Bin-picking. SI2019.
- [13] **Xinyi Zhang**, Damien Petit, Yukiyasu Domae, Ixchel G. Ramirez-Alpizar, Weiwei Wan, Kensuke Harada. A Real-time Robotic Calibration Method for Vision-based Bin-picking. ROBOMECH2019.

PATENTS

- [1] 原田研介, **張馨藝 (Xinyi Zhang)**, 堂前幸康, 万偉偉, 森建郎. ワーク取出し装置. 特開 2023-095329, 2023.
- [2] 原田研介, 万偉偉, 堂前幸康, **張馨藝** (Xinyi Zhang), 森建郎, 吹田和嗣, 五十嵐淳. ワーク取り出し装置、ワーク取り出し方法、プログラム及び制御装置. 特開 2021-186542, 2021.

AWARDS AND HONORS

Best Presentation Award (優秀講演賞)	12/2021
SICE SI2021	
Young Scientist Incentive Award (若手奨励賞)	12/2021
SICE SI Division	
Japan Joint Chapter Young Award (IROS, CASE2021) IEEE Robotics and Automation Society	10/2021
Scholarship Kobayashi Foundation (公益財団法人小林財団)	04/2021 - 03/2023
Best Presentation Award (優秀講演賞)	12/2020
SICE SI2020	